

Rev. 2 May 2017

以下信息已提供符合电子信息产品的对电子信息产品污染控制管理办法规定中国的污染控制 SJ/T t11364-2014 标记。

The following information has been made available to comply with SJ/T11364-2014 Marking for Control of Pollution Caused by Electronic Information Products as required by China's Management Methods for the Control of Pollution from Electronic Information Products.

以下有害物质披露表适用于Xilinx集成电路包含在SJ / t11364-2014在均质材料的限制要求，是否含有过量的铅。适用于以下产品：包装码BF、BG、CL、CP、CS、FB、FF、FG、FS、FT、HQ、PC、PD PQ, SF, 因此, TQ, VO, VQ, BFG, FFG, FBG, FHG, FLG, FSG, SBG · SFG, RFG。一个例子，在哪里找到包代码显示在下面的图片
The following hazardous substance disclosure table applies to Xilinx integrated circuits which contain lead in excess of the homogenous material limit requirements in SJ/T11364-2014. This applies to products with the following package codes: BF, BG, CL, CP, CS, FB, FF, FG, FS, FT, HQ, PC, PD PQ, SF, SO, TQ, VO, VQ, BFG, FFG, FBG, FHG, FLG, FSG, SBG, SFG, RFG. An example of where to find the package code is shown in the image below.

赛灵思标准集成电路
封装代码示例
*Example of a Xilinx
standard integrated
circuit package code*



危险物质名称和浓度表

Table of hazardous substances' name and concentration

组件名称 Component name	危险物质名称和浓度					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6+)	多溴联苯 (PBB)	多溴联苯醚 (PBDE)
BGA BGA Flip Chip (BGA倒装芯片)	X	O	O	O	O	O

O: 表明此有毒或有害物质包含在本部分的所有均质材料中，根据 EIP-A, EIP-B, EIP-C 低于极限要求 JS/T11363-2014

O: Indicates that this toxic or hazardous substance contained in all the homogeneous materials for this part, according to EIP-A, EIP-B, EIP-C is below the limit requirement in JS/T11363-2014

X: 表明此有毒或有害物质包含在本部分的所有均质材料中，根据 EIP-A, EIP-B, EIP-C 超过限额要求 JS/T11363-2014

X: Indicates that this toxic or hazardous substance contained in all the homogeneous materials for this part, according to EIP-A, EIP-B, EIP-C is above the limit requirement in JS/T11363-2014



这些产品的环保使用期为

The Environment Friendly Use Period for these products is:

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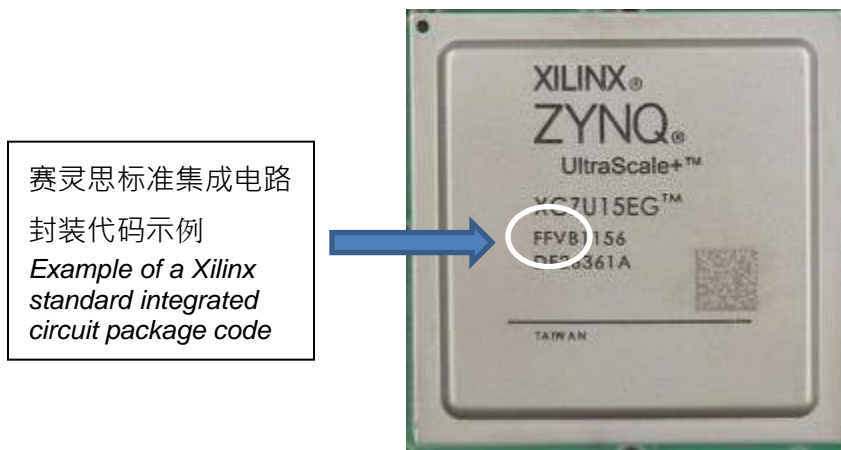
以下信息已提供符合电子信息产品的对电子信息产品污染控制管理办法规定中国的污染控制

SJ/T t11364-2014 标记。

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符合RoHS标准的集成电路包括那些与三个数字封装代码结束与字母“V”和引线键合封装如 BGG, CLG, CPG, CSG, FGG, FTG, HQG, PCG, PDG, PQG, TQG, QFG, VQG, VOG

RoHS compliant integrated circuits include those with three digit package codes ending with the letter 'V' and wire bond packages BGG, CLG, CPG, CSG, FGG, FTG, HQG, PCG, PDG, PQG, TQG, QFG, VQG, VOG



危险物质名称和浓度表

Table of hazardous substances' name and concentration

组件名称 Component name						
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6+)	多溴化联苯 (PBB)	多溴联苯醚 (PBDE)
标准集成电路 Standard Integrated Circuit	O	O	O	O	O	O

O: 表明此有毒或有害物质包含在本部分的所有均质材料中，根据 EIP-A, EIP-B, EIP-C 低于极限要求 JS/T11363-2014

O: Indicates that this toxic or hazardous substance contained in all the homogeneous materials for this part, according to EIP-A, EIP-B, EIP-C is below the limit requirement in JS/T11363-2014

X: : 表明此有毒或有害物质包含在本部分的所有均质材料中，根据 EIP-A, EIP-B, EIP-C 超过限额要求 JS/T11363-2014

X: Indicates that this toxic or hazardous substance contained in all the homogeneous materials for this part, according to EIP-A, EIP-B, EIP-C is above the limit requirement in JS/T11363-2014

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有害物质披露表：开发包

Hazardous Substance Disclosure Table for: DEVELOPMENT KITS

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The following information has been made available to comply with SJ/T11364-2014 Marking for Control of Pollution Caused by Electronic Information Products as required by China's Management Methods for the Control of Pollution from Electronic Information Products.

下列有害物质披露表适用于Xilinx开发套件，不是欧盟RoHS标准。这适用于所有的开发板和附件产品，没有在产品/部件代码结束时由单个字母“G”指定

The following hazardous substance disclosure table applies to Xilinx development kits that are not EU RoHS Compliant. This applies to all development boards and accessory products that are NOT designated by the single letter 'G' at the end of the product/part code.

危险物质名称和浓度表

Table of hazardous substances' name and concentration

组件名称 Component name						
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6+)	多溴化联苯 (PBB)	多溴联苯醚 (PBDE)
印刷电路板组件 Printed Circuit Board Assembly	X	X	X	X	X	X
电缆及电缆附件 Cables and Cable Accessories	X	X	X	X	X	X
电源 Power Supply	X	X	X	X	X	X

O: 表明此有毒或有害物质包含在本部分的所有均质材料中，根据 EIP-A, EIP-B, EIP-C 低于极限要求 JS/T11363-2014

O: Indicates that this toxic or hazardous substance contained in all the homogeneous materials for this part, according to EIP-A, EIP-B, EIP-C is below the limit requirement in SJ/T11363-2014

X: 表明此有毒或有害物质包含在本部分的所有均质材料中，根据 EIP-A, EIP-B, EIP-C 超过限额要求 JS/T11363-2014

(本表提供的信息仅用于符合SJ / T11364-2014和“电子信息产品污染控制管理办法”)

X: Indicates that this toxic or hazardous substance may be contained in all the homogeneous materials for this part, according to EIP-A, EIP-B, EIP-C is above the limit requirement in SJ/T11363-2014 (Information provided in this table is solely for compliance with SJ/T11364-2014 and the Management Measures for the Control of Pollution by Electronic Information Products.)



这些产品的环保使用期为

The Environment Friendly Use Period for these products is:

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The following information has been made available to comply with SJ/T11364-2014 Marking for Control of Pollution Caused by Electronic Information Products as required by China's Management Methods for the Control of Pollution from Electronic Information Products.

以下有害物质披露表适用于赛灵思USBX电缆是欧盟RoHS的豁免。

The following hazardous substance disclosure table applies to Xilinx USBX cable which is EU RoHS compliant by exemption.

危险物质名称和浓度表
 Table of hazardous substances' name and concentration

组件名称 Component name	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr6+)	多溴化联苯 (PBB)	多溴联苯醚 (PBDE)
	电缆及电缆附件 Cables and Cable Accessories	X	0	0	0	0

O: 表明此有毒或有害物质包含在本部分的所有均质材料中·根据 EIP-A, EIP-B, EIP-C低於極限要求 JS/T11363-2014
 O: Indicates that this toxic or hazardous substance contained in all the homogeneous materials for this part, according to EIP-A, EIP-B, EIP-C is below the limit requirement in SJ/T11363-2014
 X: : 表明此有毒或有害物质包含在本部分的所有均质材料中·根据 EIP-A, EIP-B, EIP-C超过限额要求 JS/T11363-2014 (本表提供的信息僅用於符合SJ / T11364-2014和“電子信息產品污染控制管理辦法”)
 X: Indicates that this toxic or hazardous substance may be contained in all the homogeneous materials for this part, according to EIP-A, EIP-B, EIP-C is above the limit requirement in SJ/T11363-2014 (*Information provided in this table is solely for compliance with SJ/T11364-2014 and the Management Measures for the Control of Pollution by Electronic Information Products.*)



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